

IXFN44N100P

1000 V, 220 mΩ Polar™ HiperFET™ Power MOSFET



Features:

- International Standard Package
- Low Intrinsic Gate Resistance
- miniBLOC with Aluminum Nitride Isolation
- Low Package Inductance
- Fast Intrinsic Rectifier
- Low $R_{DS(on)}$ and Q_G

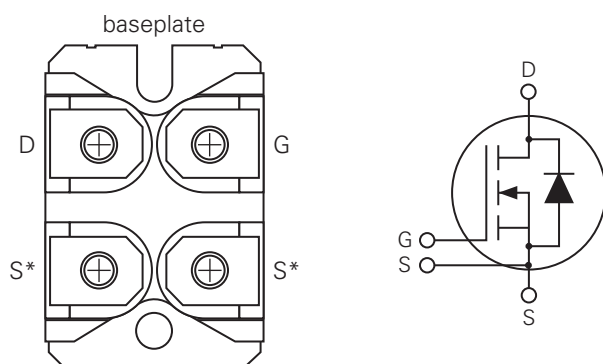
Advantages:

- High Power Density
- Easy to Mount
- Space Savings

Applications:

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- AC Motor Control
- High Speed Power Switching Application

Pinout Diagram (SOT-227B)



G: Gate; **D:** Drain; **S:** Source; **baseplate:** Isolated

* Either Source terminal can be used as main or Kelvin Source

Product Summary

Characteristic	Value	Unit
V_{DSS}	1000	V
I_{D25}	37	A
$R_{DS(on)}$	≤ 220	mΩ
t_{rr}	≤ 300	ns

Maximum Ratings

Symbol	Characteristics	Conditions		Value	Units
V _{DSS}	Drain-Source Voltage	T _J = 25°C to 150°C		1000	V
V _{DGR}	Drain-Gate Voltage	T _J = 25°C to 150°C, R _{GS} = 1 mΩ		1000	V
V _{GSS}	Gate-Source Voltage	Continuous		±30	V
V _{GSM}		Transient		±40	
I _{D25}	Drain Current	T _C = 25°C		37	A
I _{DM}		T _C = 25°C, Pulse width limited by T _{JM}		110	
I _A	Avalanche Current	T _C = 25°C		22	A
E _{AS}	Avalanche Energy	T _C = 25°C		2	J
dV/dt	Reverse Diode dV/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C		20	V/ns
P _D	Power Dissipation	T _C = 25°C		890	W
T _J	Operating Junction Temperature	–		-55 to +150	°C
T _{JM}	Maximum Junction Temperature	–		150	
T _{stg}	Storage Temperature	–		-55 to +150	
V _{ISOL}	Isolation Voltage	50/60 Hz, RMS, I _{ISOL} ≤ 1 mA	t = 1 min	2500	V~
			t = 1 s	3000	
M _d	Mounting Torque for Base Plate	–		1.5/13	Nm/lb.in
	Terminal Connection Torque	–		1.3/11.5	Nm/lb.in
W	Weight	–		30	g

Thermal Characteristics

Symbol	Characteristic	Value			Unit
		Min.	Typ.	Max.	
$R_{th, JC}$	Thermal Resistance, junction-to-case	–	–	0.14	$^\circ\text{C/W}$
$R_{th, CS}$	Thermal Resistance, case to heat sink	–	0.05	–	$^\circ\text{C/W}$

Electrical Characteristics – Static ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 3\text{ mA}$, $V_{GS} = 0\text{ V}$	1000	–	–	V
$V_{GS(th)}$	Gate Threshold Voltage	$I_D = 1\text{ mA}$, $V_{GS} = V_{DS}$	3.5	–	6.5	V
I_{GSS}	Gate-Source Leakage Current	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 30\text{ V}$	–	–	± 200	nA
I_{DSS}	Drain-Source Current	$V_{DS} = V_{DSS}$, $V_{GS} = 0\text{ V}$	–	–	50	μA
		$V_{DS} = V_{DSS}$, $V_{GS} = 0\text{ V}$, $T_J = 125^\circ\text{C}$	–	–	3	mA
$R_{DS(on)}$	Drain-Source On-Resistance ¹	$V_{GS} = 10\text{ V}$, $I_D = 22\text{ A}$	–	–	220	m Ω

Note 1: Pulse test, $t \leq 300\text{ }\mu\text{s}$, duty cycle, $d \leq 2\%$

Electrical Characteristics – Dynamic ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
g_{fs}	Transconductance ¹	$V_{DS} = 20\text{ V}, I_D = 22\text{ A}$	20	35	–	S
R_{Gi}	Gate Input Resistance	–	–	1.4	–	Ω
C_{iss}	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	–	16.9	–	nF
C_{oss}	Output Capacitance		–	1100	–	pF
C_{rss}	Reverse Transfer Capacitance		–	184	–	pF
$Q_{g(on)}$	Total Gate Charge	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \times V_{DSS},$ $I_D = 22\text{ A}$	–	350	–	nC
Q_{gs}	Gate-Source Charge		–	104	–	
Q_{gd}	Gate-Drain Charge		–	126	–	
$t_{d(on)}$	Turn-on Delay Time	Resistive Switching $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \times V_{DSS},$ $I_D = 22\text{ A}, R_{G(ext)} = 1\ \Omega$	–	60	–	ns
t_r	Rise Time		–	68	–	
$t_{d(off)}$	Turn-off Delay Time		–	90	–	
t_f	Fall Time		–	54	–	

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Source-Drain Diode Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Conditions	Value			Unit
			Min.	Typ.	Max.	
I_S	Continuous Diode Forward Current	$V_{GS} = 0\text{ V}$	–	–	44	A
I_{SM}	Diode Pulse Current	Repetitive, Pulse width limited by T_{JM}	–	–	176	A
V_{SD}	Diode Forward Voltage ¹	$I_F = I_S, V_{GS} = 0\text{ V}$	–	–	1.5	V
t_{rr}	Reverse Recovery Time	$I_F = 22\text{ A}, -di/dt = 100\text{ A}/\mu\text{s},$ $V_r = 100\text{ V}, V_{GS} = 0\text{ V}$	–	–	300	ns
Q_{rm}	Reverse Recovery Charge		–	2.5	–	μC
I_{rm}	Reverse Recovery Current		–	17.0	–	A

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Characteristic Curves

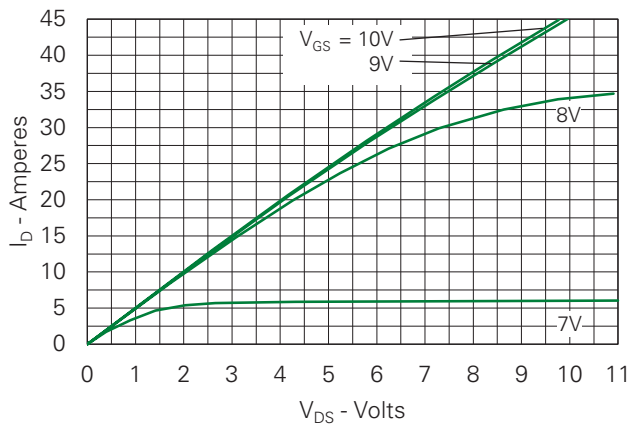
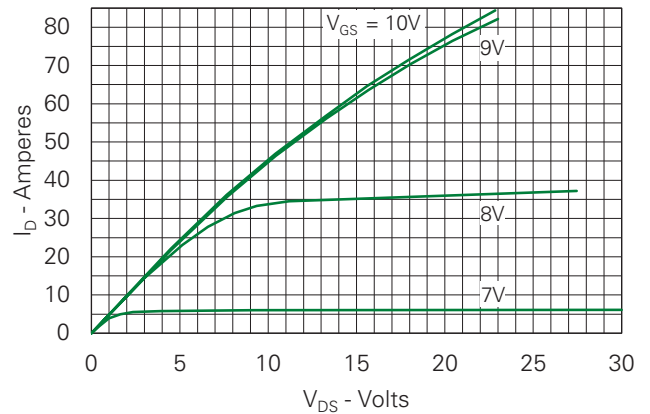
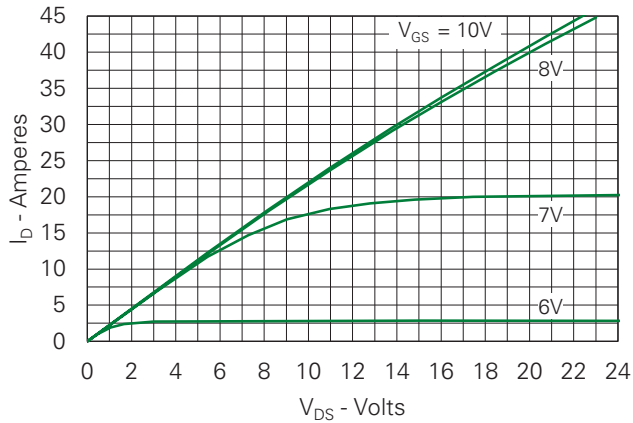
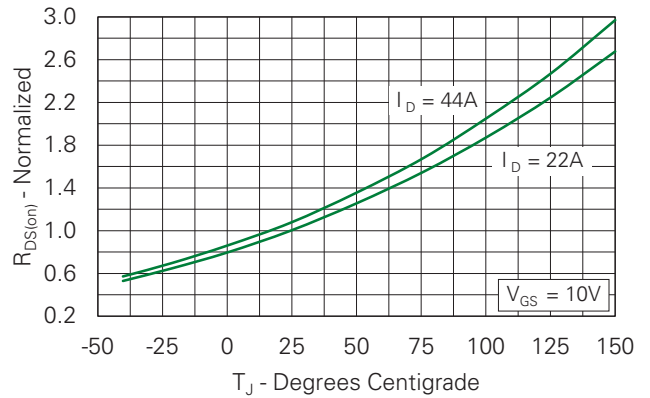
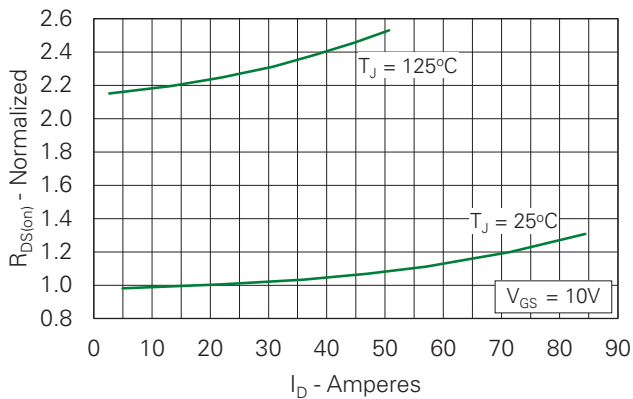
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$ Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 22\text{A}$ Value vs. Junction TemperatureFig. 5. $R_{DS(on)}$ Normalized to $I_D = 22\text{A}$ Value vs. Drain Current

Fig. 6. Maximum Drain Current vs. Case Temperature

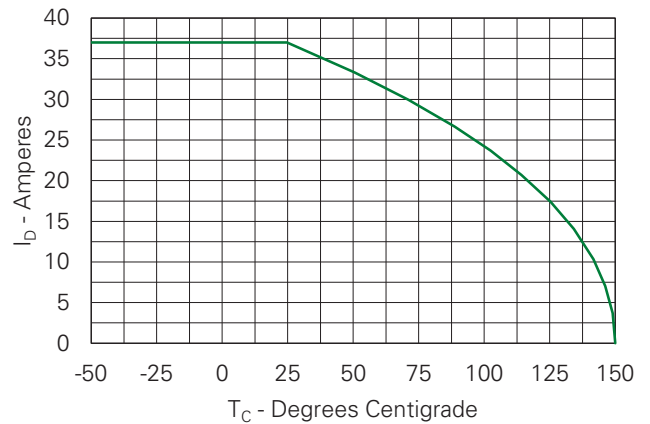


Fig. 7. Input Admittance

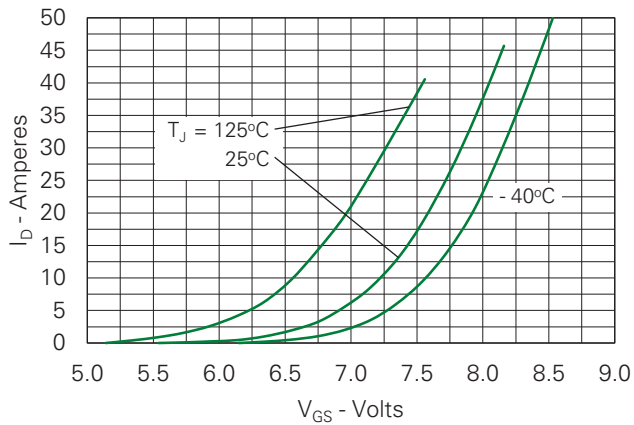


Fig. 8. Transconductance

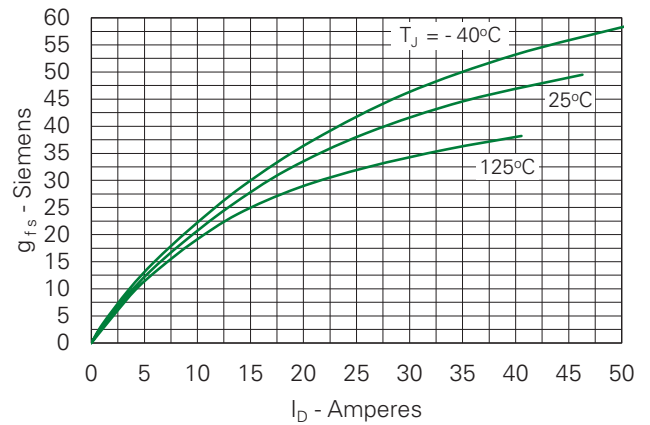


Fig. 9. Forward Voltage Drop of Intrinsic Diode

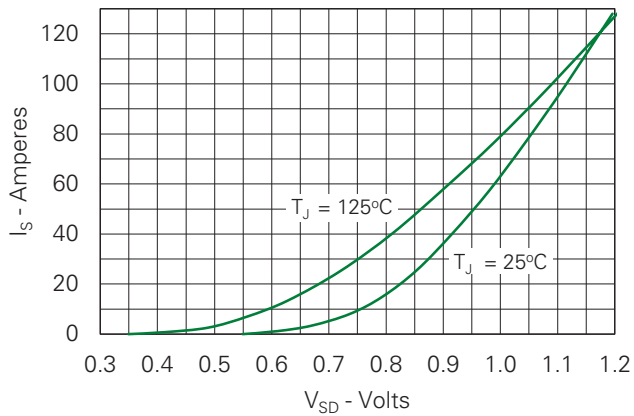


Fig. 10. Gate Charge

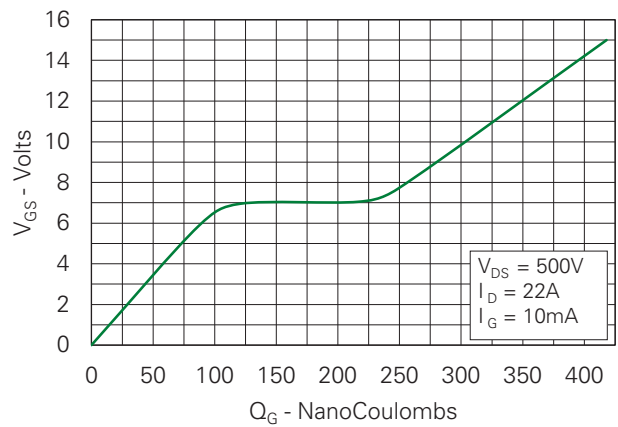


Fig. 11. Capacitance

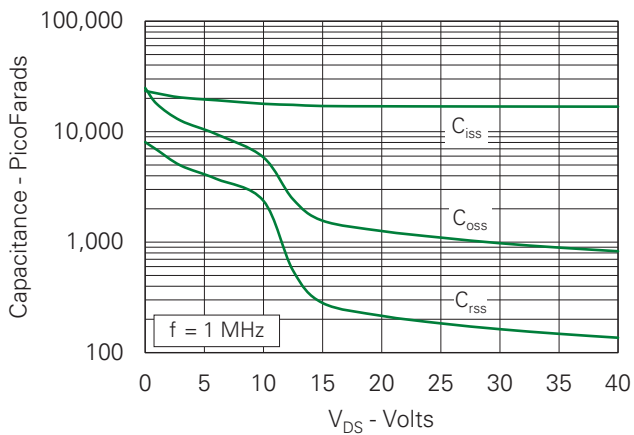
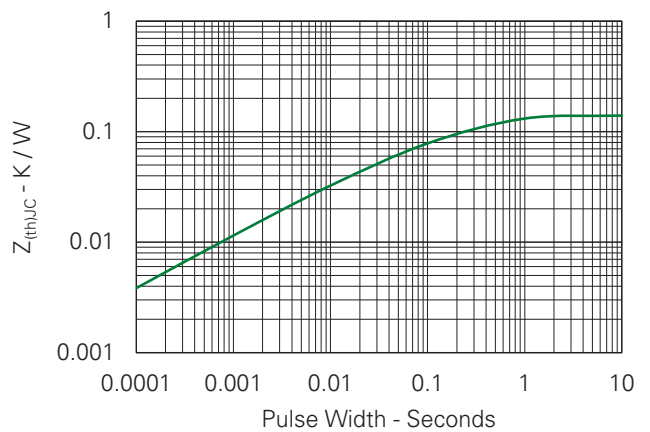
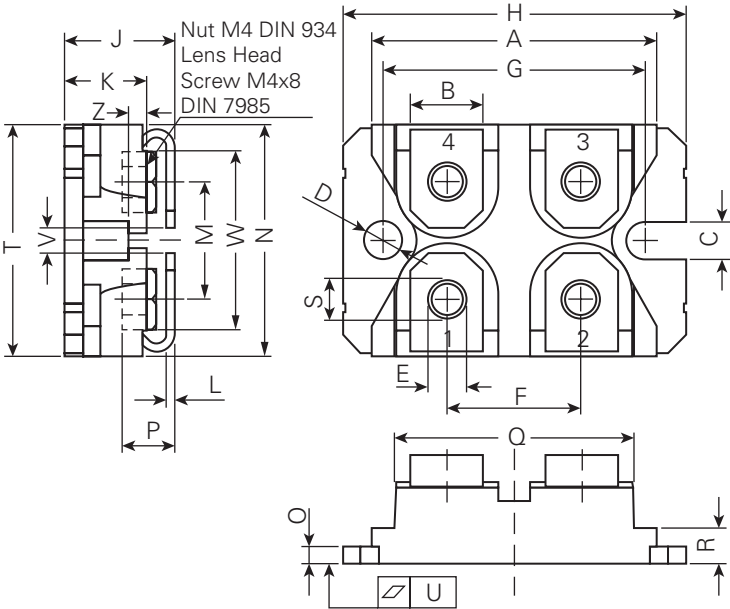


Fig. 12. Maximum Transient Thermal Impedance



Part Outline Drawing (SOT-227B)



Symbol	Inches		Millimeters	
	Min.	Max.	Min.	Max
A	1.240	1.255	31.50	31.88
B	0.307	0.323	7.80	8.20
C	0.161	0.169	4.09	4.29
D	0.161	0.169	4.09	4.29
E	0.161	0.169	4.09	4.29
F	0.587	0.595	14.91	15.11
G	1.186	1.193	30.12	30.30
H	1.488	1.505	37.80	38.23
J	0.460	0.481	11.68	12.22
K	0.351	0.378	8.92	9.60
L	0.029	0.033	0.74	0.84
M	0.492	0.516	12.50	13.10
N	0.990	1.001	25.15	25.42
O	0.077	0.084	1.95	2.13
P	0.195	0.244	4.95	6.20
Q	1.045	1.059	26.54	26.90
R	0.155	0.167	3.94	4.42
S	0.179	0.191	4.55	4.85
T	0.968	0.994	24.59	25.25
U	- 0.002	0.004	-0.05	0.10
V	0.126	0.217	3.20	5.50
W	0.780	0.830	19.81	21.08
Z	.098	0.106	2.50	2.70

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